

Abstract

Leadframe-based component housing, leadframe ribbon, surface-mountable electronic
5 component and method of production

The invention describes a leadframe-based housing for a surface-mountable component,
particularly a radiation-emitting component. Said leadframe-based housing comprises electrical
connector strips and at least one chip mounting area, and provided according to the invention in
10 one of the connector strips is an injection aperture that enables a leadframe-based housing to be
produced with a very small thickness in an injection molding process. A method for producing
such housings is further specified.

Figure 4b

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